

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



### Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







# **Ceramic Resonators, Chip Type** (3 Array Type)

Type: **EFOS** 

Type: **EFOB**Type: **EFOSS** 

Type: **EFOSM** 

Type: **EFOBM** 

Type: **EFOJM** 

#### Features

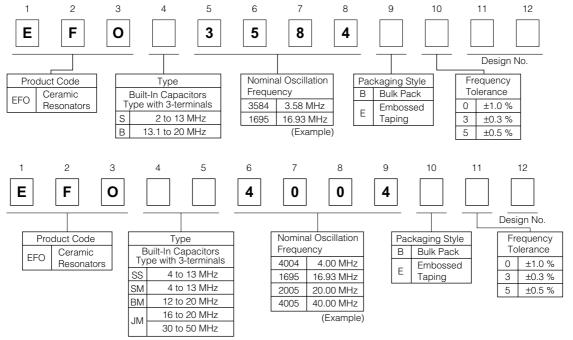
- Encased in a ceramic package
- High reliability against soldering heat and mechanical stress
- Moisture-proof sealing
- 1.2 mm maximum (SS/SM/BM/JM),
- Designed for reflow soldering
- Flat-bottom plate for better mountings
- Simplifies oscillation circuits by reducing the number of circuit parts
- RoHS compliant



#### ■ Recommended Applications

- Clock generator for microprocessors
- Carrier circuit between telecommunication equipment (Telephone to telephone, personal computer to printer)
- Handling Precautions (See Page 175 to 176)
- Packaging Specifications
  See Page 169 to 177

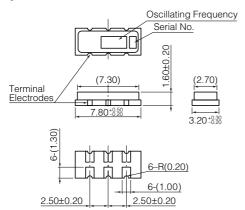
#### ■ Explanation of Part Numbers



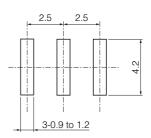
Part Number	Frequency range (MHz)	Frequency Temperature Characteristics (-20 to +80 °C)	Built-in Capacitors (Reference)
EFOS	2.00 to 8.39	±0.2 %	33 pF
	8.40 to 13.0	±1.0 %	
EFOB	13.1 to 20.0	±0.5 %	33 pF
EFOSS	4.00 to 8.39	±0.2 %	21 pF
EF033	8.40 to 13.0	±0.3 %	21 βΙ
EFOSM	4.00 to 8.39	±0.2 %	33 pF
EFOSIVI	8.40 to 13.0	±1.0 %	33 με
EFOBM	12.0 to 20.0	±0.3 %	18 pF
EFOJM	16.0 to 20.0	±0.5 %	10 pE
EFOJIVI	30.0 to 50.0	±0.2 %	10 pF

### ■ Dimensions in mm (not to scale) Recommended Land Dimensions

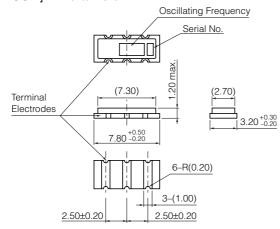
[Type EFOS] .... 2.0 to 13.0 MHz



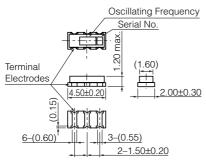
#### [Type EFOS, EFOSM]



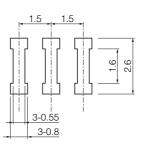
[Type EFOSM]·····4.0 to 13.0 MHz



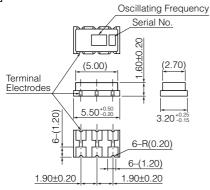
[Type EFOSS]  $\cdots$  4.0 to 13.0 MHz



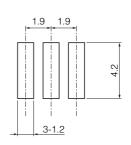
[Type EFOSS]



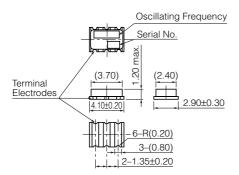
[Type EFOB].....13.1 to 20.0 MHz



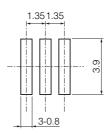
[Type EFOB]



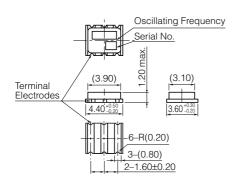
## ■ Dimensions in mm (not to scale) Recommended Land Dimensions [Type EFOBM]·····12.0 to 20.0 MHz



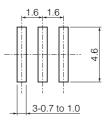
#### [Type EFOBM]



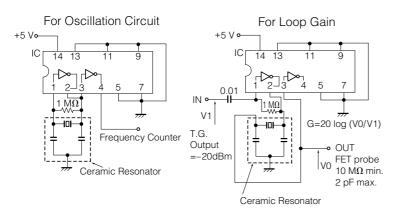
[Type EFOJM].....16.0 to 20.0, 30.0 to 50.0 MHz



[Type EFOJM]

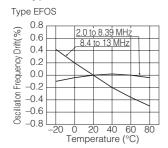


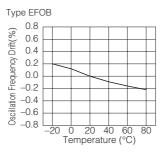
#### ■ Test Circuits Diagram

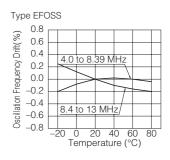


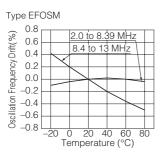
Frequency	IC
2.00 to 8.39 MHz	µPD4069UBC, TC4069UBP or similar
8.40 to 50.0 MHz	µPD74HCU, TC74 HCU04AP or similar

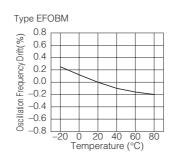
#### ■ Typical Characteristics ..... Temperature Characteristics

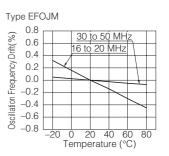










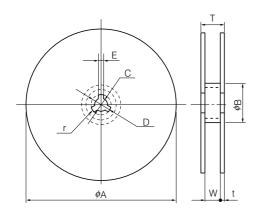


#### ■ Packaging Specifications

#### Standard Packing Quantity

Туре	Embossed Taping	Bulk
EFOS, EFOSM	2500 pcs./reel	
EFOSS	2000 pcs./reel	500 pcs./bag
EFOB , EFOBM, EFOJM	1000 pcs./reel	

#### • Dimensions for Reel in mm (not to scale)



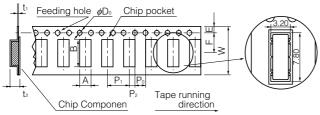
#### [Type EFOS, EFOSM]

Dim.	φA	φB	С	D	E
(mm)	330±5	80 min.	13.0±0.5	21.0±0.8	2.0±0.5
Dim.	W	Т	t	ŗ	
(mm)	16.4+2.0	22.4 max.	3 max.	1.0	

#### [Type EFOSS, EFOB, EFOBM, EFOJM]

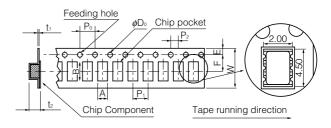
Dim.	φΑ	φB	С	D	E
(mm)	180±5	60 min.	13.0±0.5	21.0±0.8	2.0±0.5
Dim.	W	Т	t	r	
(mm)	12.4 +2.0	18.4 max.	3 max.	1.0	

#### [Type EFOS, EFOSM]



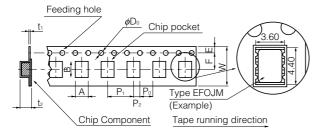
Dim.	А	В	W	F	E	P <sub>1</sub>
(mm)	3.7±0.2	8.3±0.2	16.0±0.3	7.5±0.1	1.75±0.10	8.0±0.1
Dim.	P <sub>2</sub>	P₀	<b>ø</b> D₀	t <sub>1</sub>	t <sub>2</sub>	
(mm)	2.0±0.1	4.0±0.1	1.5+0.1	0.3	3.5 max.	

#### [Type EFOSS]



Dim.	А	В	W	F	E	P <sub>1</sub>
(mm)	2.6±0.2	5.1±0.2	12.0±0.3	5.5±0.1	1.75±0.10	4.0±0.1
Dim.	P <sub>2</sub>	P <sub>0</sub>	φD <sub>0</sub>	t <sub>1</sub>	t <sub>2</sub>	•

#### [Type EFOB, EFOBM, EFOJM]



Dim.	Α	В	W	F	E	P <sub>1</sub>
(mm)	1	2	12.0±0.3	5.5±0.1	1.75±0.10	8.0±0.1
Dim.	P <sub>2</sub>	P <sub>0</sub>	<b>φ</b> D₀	t <sub>1</sub>	t <sub>2</sub>	
(mm)	2.0±0.1	4.0±0.1	1.5 <sup>+0.1</sup>	0.6 max.	3.0 max.	

Dim. (mm)	А	В
	①	2
Type EFOB	3.7±0.2	6.0±0.2
Type EFOBM	3.4±0.2	4.6±0.2
Type EFOJM	4.1±0.2	4.9±0.2